STL36DN6F7



Dual N-channel 60 V, 23 mΩ typ., 33 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 double island package

Datasheet - production data

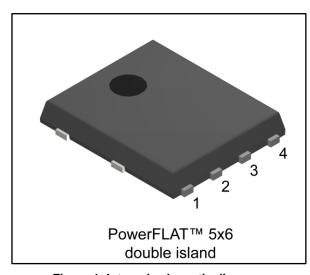
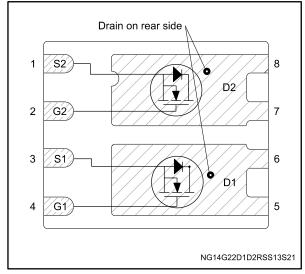


Figure 1: Internal schematic diagram



Features

Order code	V _{DS} R _{DS(on)} max		l _D
STL36DN6F7	60 V	27 mΩ	33 A

- Among the lowest R_{DS(on)} on the market
- Excellent figure of merit (FoM)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness

Applications

• Switching applications

Description

This dual N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packing
STL36DN6F7	36DN6F7	PowerFLAT™ 5x6 double island	Tape and reel

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STL36DN6F7 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	60	V	
V_{GS}	Gate-source voltage	±20	V	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	33	Α	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	23	Α	
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} = 25 °C	9	Α	
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} =100°C	6.7	Α	
I _{DM} ⁽¹⁾⁽³⁾	Drain current (pulsed)	132	Α	
I _{DM} ⁽²⁾⁽³⁾	Drain current (pulsed)	36	Α	
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25 °C	58	W	
P _{TOT} ⁽²⁾	Total dissipation at T _{pcb} = 25°C	4.8	W	
TJ	Operating junction temperature range	FF to 17F	°C	
T _{stg}	-55 to 175 torage temperature range			

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction- case	2.6	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	31.3	°C/W

Notes:

 $^{(1)}$ When mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.

 $[\]ensuremath{^{(1)}}\xspace$ This value is rated according to $R_{thj\text{-c}}.$

 $[\]ensuremath{^{(2)}} The value is rated according to <math display="inline">R_{thj\text{-pcb}}.$

 $^{^{(3)}}$ Pulse width limited by safe operating area.

Electrical characteristics STL36DN6F7

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	60			V
IDSS	Zero gate voltage drain current	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V ,V _{GS} = 20 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 4.5 A		23	27	mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance	V 00 V (4 MI)	ı	420	-	pF
Coss	Output capacitance	V _{DS} = 30 V, f = 1 MHz, V _{GS} = 0 V		215	-	pF
Crss	Reverse transfer capacitance	VGS - 0 V	ı	16	-	pF
Q_g	Total gate charge	$V_{DD} = 30 \text{ V}, I_{D} = 9 \text{ A}$	ı	8	-	nC
Qgs	Gate-source charge	$V_{GS} = 0$ to 10 V	ı	2.3	-	nC
Q_{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	2.1	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 30 \text{ V}, I_D = 4.5 \text{ A},$	1	7.85	ı	ns
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 13: "Test circuit	1	3.25	ı	ns
t _{d(off)}	Turn-off delay time	for resistive load switching	1	12.1	•	ns
t _f	Fall time	times" and Figure 18: "Switching time waveform")	1	3.95	•	ns

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{SD} ⁽¹⁾	Forward on voltage	I _{SD} = 9 A, V _{GS} = 0 V	ı		1.2	V
t _{rr}	Reverse recovery time	everse recovery time $I_D = 9 \text{ A}$, $di/dt = 100 \text{ A/µs}$		17.1		ns
Qrr	Reverse recovery charge	V _{DD} = 48 V (see Figure 15: "Test circuit	ı	6.67		nC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	1	0.8		Α

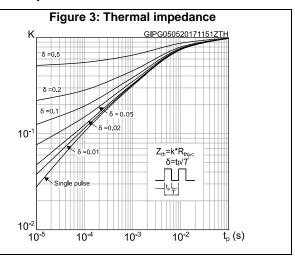
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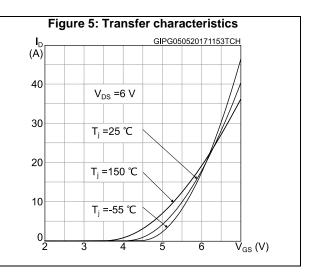
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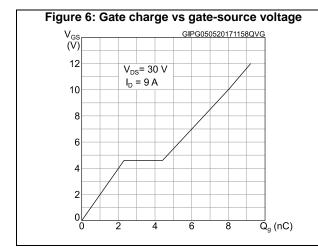
 $^{^{(1)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area (A) Operation in this area is limited by R_{DS(on)} GIPG050520171148SOA 10² t_p=10 μs 10¹ t₀=100 µs T_j≤175 °C 10⁰ $T_c = 25 \,^{\circ}\text{C}$ t₀=1 ms single pulse t₀=10 ms 10-1 10⁰ $\overline{V}_{DS}(V)$







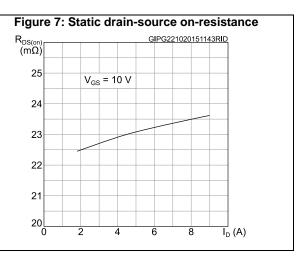
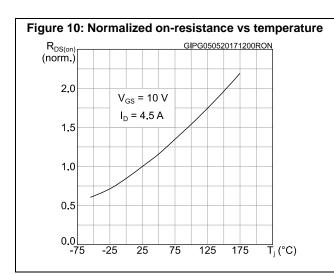
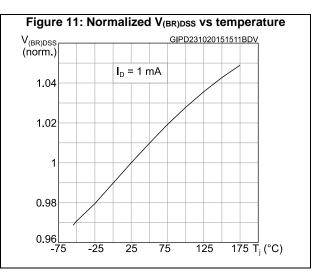
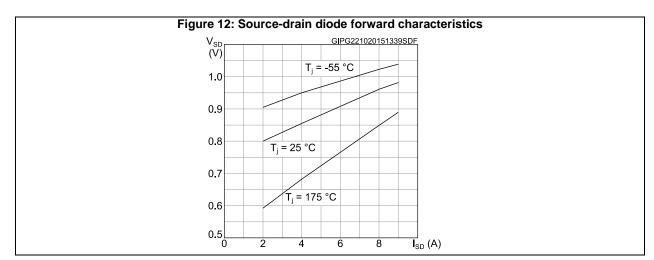




Figure 8: Capacitance variations C (pF) GIPG050520171159CVR C_{ISS} Coss 10² 10 C_{RSS} f = 1 MHz 10⁰ 50 10 20 30 40 60 $\overline{V}_{DS}(V)$







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STL36DN6F7 Test circuits

3 Test circuits

Figure 13: Test circuit for resistive load switching times

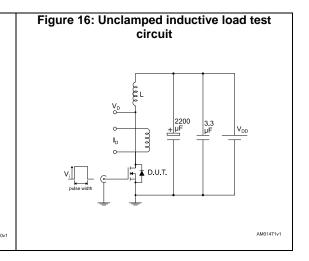
Figure 14: Test circuit for gate charge behavior

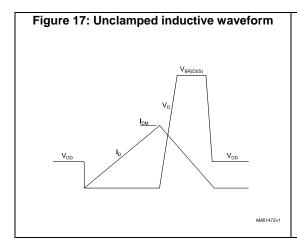
12 V 47 kΩ 100 nF 1 kΩ

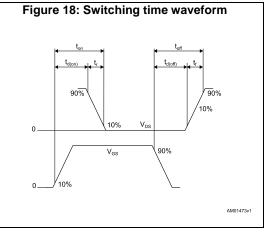
Vos 1 Lo CONST 100 Ω D.U.T.

2200 VG AM01469v1

Figure 15: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

STL36DN6F7 Package information

4.1 PowerFLAT 5x6 double island type C package information

Figure 19: PowerFLAT™ 5x6 double island type C package outline

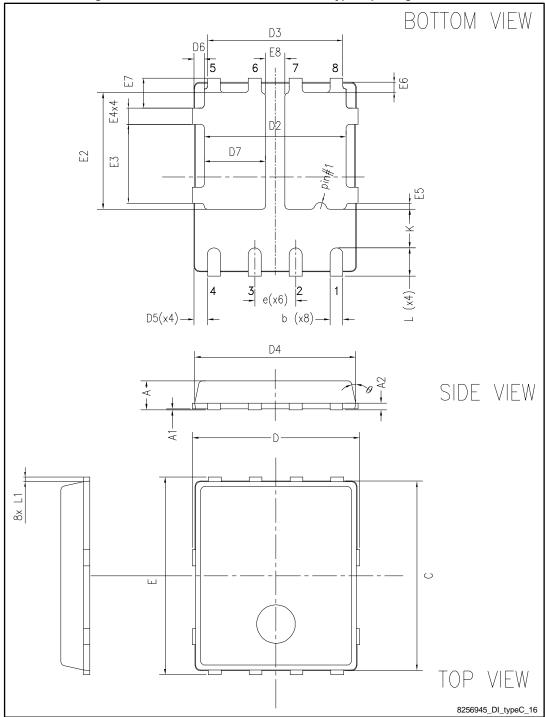
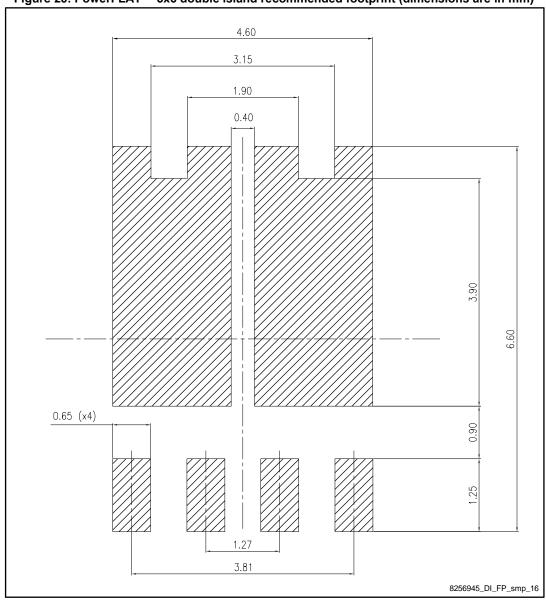


Table 8: PowerFLAT™ 5x6 double island type C mechanical data

	8: PowerFLAT *** 5x6 dour	mm	THE PERSON NAMED IN COLUMN TWO IS NOT THE PERSON NAMED IN COLUMN TWO IS NAM		
Dim.	Min.	Тур.	Max.		
А	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
С	5.80	6.00	6.20		
D	5.00	5.20	5.40		
D2	4.15		4.45		
D3	4.05	4.20	4.35		
D4	4.80	5.00	5.20		
D5	0.25	0.40	0.55		
D6	0.15	0.30	0.45		
D7	1.68		1.98		
е		1.27			
E	5.95	6.15	6.35		
E2	3.50		3.70		
E3	2.35		2.55		
E4	0.40		0.60		
E5	0.08		0.28		
E6	0.20	0.325	0.45		
E7	0.75	0.90	1.05		
E8	0.55		0.75		
K	1.05		1.35		
L	0.725		1.025		
L1	0.05	0.15	0.25		
θ	0°		12°		

STL36DN6F7 Package information

Figure 20: PowerFLAT™ 5x6 double island recommended footprint (dimensions are in mm)



Package information STL36DN6F7

4.2 Packing information

Figure 21: PowerFLAT™ 5x6 tape (dimensions are in mm)

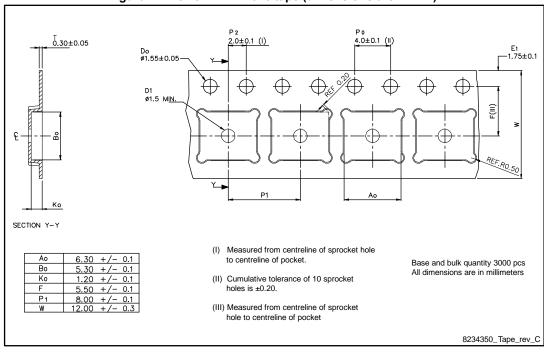
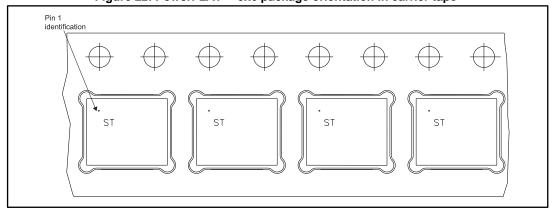


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape



STL36DN6F7 Package information



Revision history STL36DN6F7

5 Revision history

Table 9: Document revision history

Date	Revision	Changes	
20-Aug-2015	1	First release.	
22-Oct-2015	2	Document status promoted from preliminary to production data. Updated Section 2: "Electrical ratings" and Section 3: "Electrical characteristics". Added Section 3.1: "Electrical characteristics (curves)".	
10-May-2017	3	Modified title and features table on cover page. Modified Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "On /off states" Modified Figure 4: "Output characteristics", Figure 5: "Transfer characteristics", Figure 7: "Static drain-source on-resistance" and Figure 12: "Source-drain diode forward characteristics". Minor text changes.	

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